Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Annli	iostion Da	to 6	hoot 27	, CED	1 76	Attorney	y Docke	et Nu	ımber	NIS-1	6657	
Appii	ication Da	ıla 5	neet 37	CFR	1.70	Applicat	tion Nu	mbe	-			
Title of	f Invention	CON	NNECTOF	R CHIP	AND M	ANUFACTU	JRING N	METH	IOD THE	REOF		
The app	lication data sh	eet is r	part of the n	rovision	al or non	provisional a	pplication	n for v	hich it is l	heina su	bmitted. The following form contains	the
bibliogra This do	aphic data arrar	ged in	a format sp leted electr	ecified l ronically	by the Ur and sub	ited States P mitted to the	atent an	id Tra	demark O	ffice as c	outlined in 37 CFR 1.76. ng the Electronic Filing System (EFS	
_												
Secre	cy Orde	r 37	CFR	5.2								
											all under a Secrecy Order pur	suant to
	`			у. Арр	lication	s that fall t	unaer s	secre	cy Orae	er may	not be filed electronically.)	
Appli	cant Info	orma	ation:									
Applic											Remove	
Applic	ant Author	ity 💿	Inventor	Ore	egal Rep	oresentative	under	35 U	.S.C. 11	7 (OParty of Interest under 35 U.S	.C. 118
Prefix	Given Nar	ne			М	iddle Nam	ne			Fami	ily Name	Suffix
	Shinji									Okam	noto	
Resid	lence Inforn		•	One)		Residency			uS Res	sidency	Active US Military Service)
City	Toyama-shi,	Toyar	ma		Coun	try Of Res	sidenc	ei	JP			
Citize	nship undei	37 C	FR 1.41((b) i	JP							
Mailin	g Address o	of Ap	plicant:									
Addre	ss 1		c/o HOK	URIKU	ELECT	RIC INDUS	STRY C	O., L	ΓD.			
Addre	ss 2		3158, SI	nimo-ok	kubo							
City	Toyam	a-shi,	Toyama				;	State	/Provin	ice		
Posta	l Code		939-229	2			Count	tryi	JP			
Applic	ant 2					•					Remove	
	ant Author	ity	Inventor	OL	egal Rep	oresentative	under	35 U	.S.C. 11	7	Party of Interest under 35 U.S	.C. 118
	Given Nar				М	Middle Name				Family Name		Suffix
	Katsumi									Takeu	uchi	
Resid	lence Inform	natio	n (Select	One)	Us	Residency	<u>' </u>	Nor	า US Res	sidency	Active US Military Service	<u> </u>
City	Toyama-shi,	Toyar	та		Coun	try Of Res	sidenc	ei	JP			
Citize	nehin unda	. 27 C	FR 1.41((b) i	JP							
Mailin	nsinh anaci	3/ 0										
Address 1 c/o HOKURIKU EL												
	g Address o		plicant:	URIKU	ELECT	RIC INDUS	STRY C	O., L	 ΓD.			
	g Address (plicant:			RIC INDUS	STRY C	O., L	ΓD.			
Addre	g Address o	of Ap	plicant: c/o HOK			RIC INDUS			ΓD. e/Provin	ıce		
Addre Addre City	g Address o	of Ap	plicant: c/o HOK 3158 Sh	imo-ok				State		ice		
Addre Addre City Postal	g Address of ss 1 ss 2 Toyama	of Ap	plicant: c/o HOK 3158 Sh Toyama	imo-ok			,	State	e/Provin	ice	Remove	
Addre Addre City Postal	g Address of ss 1 ss 2 Toyama	of Ap	plicant: c/o HOK 3158 Sh Toyama 939-229	imo-ok	ubo		Count	State try ⁱ	Provin JP		Remove Party of Interest under 35 U.S	C. 118
Addre Addre City Postal	g Address of ss 1 ss 2 Toyama I Code cant 3	a-shi,	plicant: c/o HOK 3158 Sh Toyama 939-229	imo-ok	ubo egal Rep		Count	State try ⁱ	Provin JP	7 (.C. 118
Addre City Postal Applic	g Address of ss 1 ss 2 Toyama I Code cant 3	a-shi,	plicant: c/o HOK 3158 Sh Toyama 939-229	imo-ok	ubo egal Rep	presentative	Count	State try ⁱ	Provin JP	7 (Party of Interest under 35 U.S	1
Addre City Postal Applic Applic Prefix	g Address of ss 1 ss 2 Toyam Code cant 3 cant Author	a-shi,	plicant: c/o HOK 3158 Sh Toyama 939-229	2	egal Rep	presentative	Count e under ne	State tryi 35 U	Provin JP	7 (Fami Nomu	Party of Interest under 35 U.S ily Name	Suffi

		<u> </u>		oo, po.	1	-			NIS-16		Ti oontanio a	Talla Olilib	control number.
Applicat	ion Da	ta She	et 37 CFR	1.76		ey Doo			1415-16	001			
					Applic	ation N	numbe	r					
Title of Invention CONNECTOR CHIP AND MANUFACTURING METHOD THEREOF													
Citizensh	p under	37 CFF	R 1.41(b) i	JP									
Mailing A	ddress o	f Appli	cant:										
Address 1		С	/o HOKURIKU	HOKURIKU ELECTRIC INDUSTRY CO., LTD.									
Address 2	2	3	158 Shimo-oku	58 Shimo-okubo									
City	Toyama	ı-shi, To	yama				State	e/Provin	ce				
Postal Co	de	9	39-2292			Cou	intry ⁱ	JP					
			sted - Additi by selecting t			Inform	ation	blocks r	may be		Add		
Corresp	onder	nce In	formatio	n:									
			umber or cor ee 37 CFR 1.		the Cor	respo	ndenc	e Inform	nation s	ection b	elow.		
☐ An A	ddress is	s being	provided fo	r the c	orrespo	ndend	e Info	rmation	of this	applicat	ion.		
Customer	Number	r	40854										
Email Add	iress		spaw@rankir	spaw@rankinhil.com Add Email Remo					Remo	ve Email			
Applicat	tion In	form	ation:										
Title of th	e Inventi	ion	CONNECTO	R CHIF	AND MA	ANUFA	CTURI	NG METH	HOD THE	REOF			
Attorney	Docket N	lumber	NIS-16657	NIS-16657 Small Entity Status Claimed									
Application	n Type		Nonprovision	Nonprovisional									
Subject M	latter		Utility										
Suggeste	d Class	(if any)					Sı	ub Class	(if any)			
Suggeste	d Techn	ology C	enter (if any)									_
Total Nun	ber of D	rawing	Sheets (if any) 5				Suggested Figure for Publication (if			(if any)	1		
Publica	ation I	nforn	nation:										
Requ	est Early	Publica	ation (Fee req	uired a	t time of	Requ	est 37	CFR 1.2	19)				
Request Not to Publish. I hereby request that the attached application not be published under 35 U.S. C. 122(b) and certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication at eighteen months after filing.													
Representative Information: Representative information should be provided for all practitioners having a power of attorney in the application. Providing this information in the Application Data Sheet does not constitute a power of attorney in the application (see 37 CFR 1.32). Enter either Customer Number or complete the Representative Name section below. If both sections													
	ted the Cu	ıstomer I	Number will be Customer	used fo	r the Rep	present	ative In		during p	rocessing		n (27 C	

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Application Da	ta Sheet 37 CFR 1.76	Attorney Docket Number	NIS-16657
Application Da	ita Sileet 37 Cl K 1.70	Application Number	
Title of Invention	CONNECTOR CHIP AND MA	NUFACTURING METHOD THE	EREOF
Customer Number	40854		

Domestic Benefit/National Stage Information:

This section allows for the applicant to either claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c) or indicate National Stage entry from a PCT application. Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a)(4), and need not otherwise be made part of the specification.

Prior Application Status	Pending	Remove					
Application Number	Continuity Type	Prior Application Number	Filing Date (YYYY-MM-DD)				
	a 371 of international	PCT/JP2004/016847	2004-11-12				
Additional Domestic Benefit/National Stage Data may be generated within this form by selecting the Add button.							

Foreign Priority Information:

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a).

una er er r r.ee(u).		Re	move				
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed				
2003-383002	JP	2003-11-12	● Yes ○ No				
Additional Foreign Priority Data may be generated within this form by selecting the Add button.							

Assignee Information:

Providing this information in the application data sheet does not substitute for compliance with any requirement of part 3 of Title 37 of the CFR to have an assignment recorded in the Office. Remove Assignee 1 If the Assignee is an Organization check here. \times Organization Name HOKURIKU ELECTRIC INDUSTRY CO., LTD. **Mailing Address Information:** Address 1 3158 Shimo-okubo Address 2 City Toyama-shi, Toyama State/Province Country | Postal Code 939-2292 Phone Number Fax Number **Email Address** Additional Assignee Data may be generated within this form by selecting the Add Add button.

Signature:

A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37 CFR 1.4(d) for the form of the signature.

PTO/SB/14 (07-07) Approved for use through 06/30/2010. OMB 0651-0032

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Application Da	ata Shaat 37 CED 1 76	Attorney Docket Number	NIS-16657
Application Data Sheet 37 CFR 1.76		Application Number	
Title of Invention	CONNECTOR CHIP AND MA	NUFACTURING METHOD THE	EREOF

Signature	/David E. Spaw/		Date (YYYY-MM-DD)	2008-06-04	
First Name	David E.	Last Name	Spaw	Registration Number	34732

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. **SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.**

Privacy Act Statement

The Privacy Act of 1974 (P.L. 93-579) requires that you be given certain information in connection with your submission of the attached form related to a patent application or patent. Accordingly, pursuant to the requirements of the Act, please be advised that: (1) the general authority for the collection of this information is 35 U.S.C. 2(b)(2); (2) furnishing of the information solicited is voluntary; and (3) the principal purpose for which the information is used by the U.S. Patent and Trademark Office is to process and/or examine your submission related to a patent application or patent. If you do not furnish the requested information, the U.S. Patent and Trademark Office may not be able to process and/or examine your submission, which may result in termination of proceedings or abandonment of the application or expiration of the patent.

The information provided by you in this form will be subject to the following routine uses:

- The information on this form will be treated confidentially to the extent allowed under the Freedom of Information Act (5 U.S.C. 552) and the Privacy Act (5 U.S.C. 552a). Records from this system of records may be disclosed to the Department of Justice to determine whether the Freedom of Information Act requires disclosure of these records.
- 2. A record from this system of records may be disclosed, as a routine use, in the course of presenting evidence to a court, magistrate, or administrative tribunal, including disclosures to opposing counsel in the course of settlement negotiations.
- 3. A record in this system of records may be disclosed, as a routine use, to a Member of Congress submitting a request involving an individual, to whom the record pertains, when the individual has requested assistance from the Member with respect to the subject matter of the record.
- 4. A record in this system of records may be disclosed, as a routine use, to a contractor of the Agency having need for the information in order to perform a contract. Recipients of information shall be required to comply with the requirements of the Privacy Act of 1974, as amended, pursuant to 5 U.S.C. 552a(m).
- 5. A record related to an International Application filed under the Patent Cooperation Treaty in this system of records may be disclosed, as a routine use, to the International Bureau of the World Intellectual Property Organization, pursuant to the Patent Cooperation Treaty.
- 6. A record in this system of records may be disclosed, as a routine use, to another federal agency for purposes of National Security review (35 U.S.C. 181) and for review pursuant to the Atomic Energy Act (42 U.S.C. 218(c)).
- 7. A record from this system of records may be disclosed, as a routine use, to the Administrator, General Services, or his/her designee, during an inspection of records conducted by GSA as part of that agency's responsibility to recommend improvements in records management practices and programs, under authority of 44 U.S.C. 2904 and 2906. Such disclosure shall be made in accordance with the GSA regulations governing inspection of records for this purpose, and any other relevant (i.e., GSA or Commerce) directive. Such disclosure shall not be used to make determinations about individuals.
- A record from this system of records may be disclosed, as a routine use, to the public after either publication of the application pursuant to 35 U.S.C. 122(b) or issuance of a patent pursuant to 35 U.S.C. 151. Further, a record may be disclosed, subject to the limitations of 37 CFR 1.14, as a routine use, to the public if the record was filed in an application which became abandoned or in which the proceedings were terminated and which application is referenced by either a published application, an application open to public inspections or an issued patent.
- 9. A record from this system of records may be disclosed, as a routine use, to a Federal, State, or local law enforcement agency, if the USPTO becomes aware of a violation or potential violation of law or regulation.